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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Venkateswaran

Docket Number: TI-34105.1

Serial No.: 10/789,646

Art Unit: 2813

Filed: 03/01/2004

Examiner: J. Dolan

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Venkateswaran		
TITLE OF INVENTION: Semiconductor Device Package and		
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